



CHENMKO ENTERPRISE CO.,LTD
SURFACE MOUNT
Power Management (Dual Transistor)

Tr1: VOLTAGE 12 Volts CURRENT 0.5 Ampere
 DTr2: VOLTAGE 50 Volts CURRENT 100 mAmpere

CHUMF4PT

Lead free devices

APPLICATION

- * Power management circuit

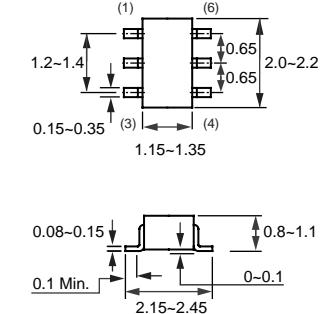
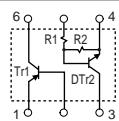
FEATURE

- * Small surface mounting type. (SC-88/SOT-363)
- * Power switching circuit in a single package.
- * Mounting cost and area can be cut in half.
- * Both the 2SA2018 & CHDTC123E in one package.
- * Built in bias resistor(R1=2.2kΩ, Typ.)



SC-88/SOT-363

CIRCUIT



Dimensions in millimeters

SC-88/SOT-363

2SA2018 LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	Collector-base voltage		—	-15	V
V _{CEO}	Collector-emitter voltage		—	-12	V
V _{EBO}	Emitter-base voltage		—	-6	V
I _C	DC Output current		—	-500	mA
I _{CP}		NOTE.1	—	-1000	
P _c	power dissipation	NOTE.2	—	150	mW
T _{STG}	Storage temperature		-55	+150	°C
T _J	Junction temperature		—	150	°C

Note

1. Single Pulse Pw=1ms
2. 120mW per element must not be exceeded
 Each terminal mounted on a recommended land.

CHDTC123E LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
Vcc	Supply voltage		–	50	V
VIN	Input voltage		-10	+20	V
Io	DC Output current IC(Max.)		–	100	mA
		NOTE.1	–	100	
Pc	Power dissipation	NOTE.2	–	150	mW
TSTG	Storage temperature		-55	+150	°C
TJ	Junction temperature		–	150	°C

Note

1. Characteristics of built-in transistor.
2. Each terminal mounter on a recommended land.

2SA2018 CHARACTERISTICS

T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
BVCEO	Collector-emitter breakdown voltage	Ic=-1mA	-12	–	–	V
BVcbo	Collector-base breakdown voltage	Ic=-10uA	-15	–	–	V
BVEBO	Emitter-base breakdown voltage	Ie=-10uA	-6	–	–	V
Icbo	Collector cut-off current	Vcb=-15V	–	–	-100	nA
Iebo	Emitter cut-off current	Veb=-6V	–	–	-100	nA
hFE	DC current gain	Vce=-2V, Ic=-10mA	270	–	680	–
Vce(sat)	Collector-emitter saturation voltage	Ic=-200mA, Ib=-10mA	–	-100	-250	mV
Cob	Collector output capacitance	Vcb=-10V, Ie=0mA, f=1MHz	–	6.5	–	pF
f _T	Transition frequency	Vce=-2V, Ie=10mA, f=100MHz	–	260	–	MHz

Note

1. Pulse test: tp≤300uS; δ≤0.02.

CHDTC123E CHARACTERISTICS

T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{loff}	Input off voltage	Io=100uA; Vcc=5.0V	0.5	–	–	V
V _{i(on)}	Input on voltage	Io=20mA; Vo=0.3V	–	–	3.0	V
V _{o(on)}	Output voltage	Io=10mA; Ii=0.5mA	–	0.1	0.3	V
I _i	Input current	Vi=5V	–	–	3.8	mA
I _{c(off)}	Output current	Vi=0V; Vcc=50V	–	–	0.5	uA
G1	DC current gain	Io=20mA; Vo=5.0V	20	–	–	–
R ₁	Input resistor		1.54	2.2	2.86	KΩ
R _{2/R₁}	Resistor ratio		0.8	1.0	1.2	–
f _T	Transition frequency	Ie=-5mA, Vce=10.0V f=100MHz	–	250	–	MHz

Note

Pulse test: tp≤300uS; δ≤0.02.

RATING CHARACTERISTIC CURVES (CHUMF4PT)

2SA2018 Typical Electrical Characteristics

Fig.1 Ground emitter propagation characteristics

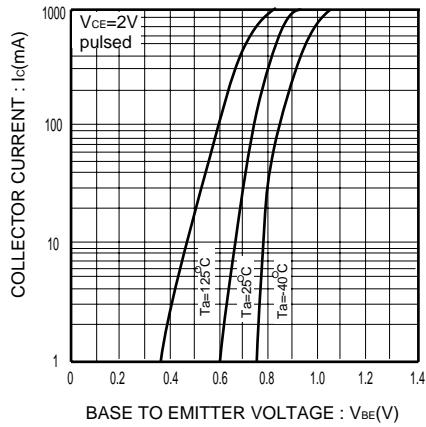


Fig.2 DC current gain vs. collector current

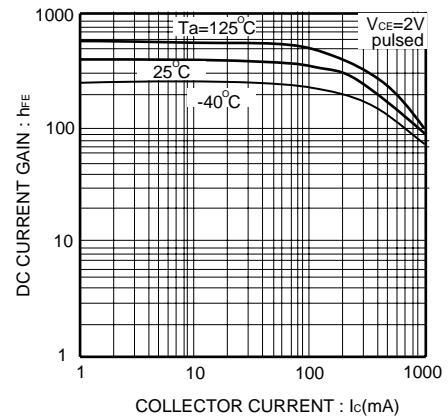


Fig.3 Collector-emitter saturation voltage vs. collector current (I)

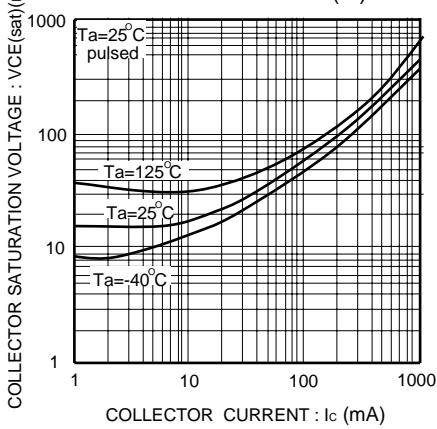
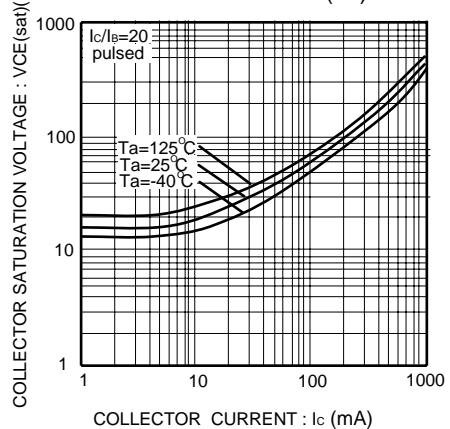


Fig.4 Collector-emitter saturation voltage vs. collector current (II)



RATING CHARACTERISTIC CURVES (CHUMF4PT)

2SA2018 Typical Electrical Characteristics

Fig.5 Base-emitter saturation voltage vs. collector current

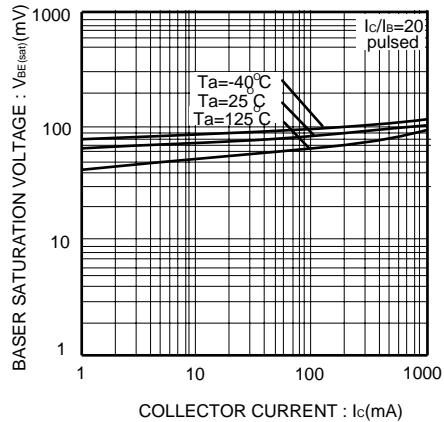


Fig.6 Gain bandwidth product vs. collector current

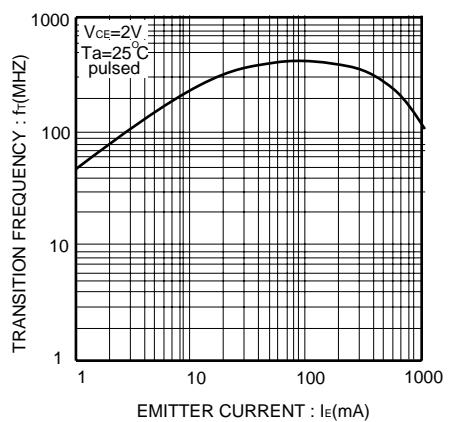
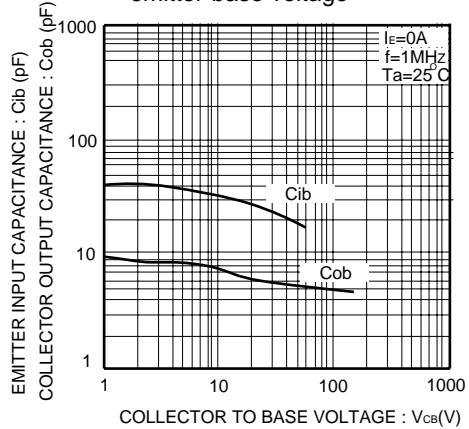


Fig.7 Collector output capacitance vs. collector-base voltage
Emitter input capacitance vs. emitter-base voltage



RATING CHARACTERISTIC CURVES (CHUMF4PT)

CHDTC123E Typical Electrical Characteristics

Fig.1 Input voltage vs. output current
(ON characteristics)

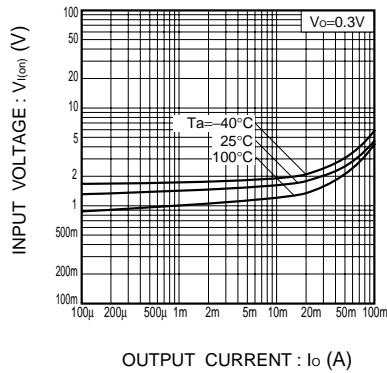


Fig.2 Output current vs. input voltage
(OFF characteristics)

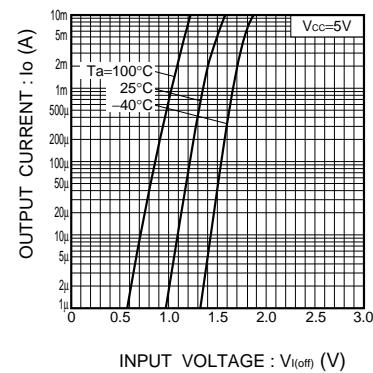


Fig.3 DC current gain vs. output current

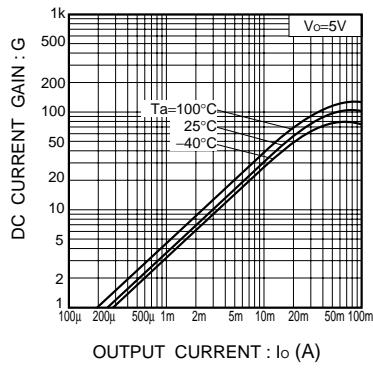


Fig.4 Output voltage vs. output current

